SCOPE :

This specification applies to the Pb Free high current type SMD inductors for MSCDRI-2D11HP-SERIES

PRODUCT INDENTIFICATION

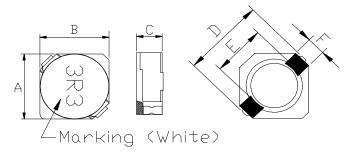
MSCDRI ·	- <u>2D11HP</u>	- <u>3R3 N</u>	
1	2	34	

① Product Code

② Dimensions Code

- ③ nductance Code
- ④ Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 3.00±0.2	mm
B: 3.00±0.2	mm
C: 1.20 Max.	mm
D: 4.50 Max.	mm
Е: 2.10 Тур.	mm
F: 1.00 Typ.	mm

(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS L : HP 4284A PRECISION LCR METER (or equivalent) RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-1 Ambient temperature $+60^{\circ}$ C Max.
- (3)-2 Operate temperature range $-40^{\circ}C \sim +125^{\circ}C$ (Including self temp. rise)
- (3)-3 Storage temperature range $-40^{\circ}C \sim +125^{\circ}C$



TABLE 1

MAGLAYERS	Inductance	Percent	Test	Resistance	Rated DC Current		Marking
PT/NO.	L(µH)	Tolerance	Frequency	RDC(Ω) Max.	IDC1(A)	IDC2(A)	warking
MSCDRI-2D11HP-1R5	1.5	Ν	100kHz/0.25V	80m	1.35	1.60	1R5
MSCDRI-2D11HP-2R2	2.2	M,N	100kHz/0.25V	0.120	1.10	1.30	2R2
MSCDRI-2D11HP-3R3	3.3	Ν	100kHz/0.25V	0.173	0.90	0.90	3R3
MSCDRI-2D11HP-4R7	4.7	Ν	100kHz/0.25V	0.238	0.75	0.85	4R7
MSCDRI-2D11HP-6R2	6.2	M,N	100kHz/0.25V	0.371	0.63	0.65	6R2
MSCDRI-2D11HP-6R8	6.8	Ν	100kHz/0.25V	0.371	0.63	0.65	6R8
MSCDRI-2D11HP-100	10	M,N	100kHz/0.25V	0.559	0.52	0.52	100
MSCDRI-2D11HP-220	22	M,N	100kHz/0.25V	1.300	0.33	0.40	220
MSCDRI-2D11HP-330	33	M,N	100kHz/0.25V	1.520	0.25	0.35	330

※ □ specify the inductance tolerance,M(±20%),N(±30%)

‰ IDC1 : Based on inductance change (Δ L/Lo : \leq drop 35%) @ ambient temp. 25℃

IDC2 : Based on temperature rise ($\triangle T$: 40°C TYP.)

Rated DC Current : The less value which is IDC1 or IDC2.



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS				
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		in figure 1 and a load applied unitil the figure in the arrow				
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)				
	no mechanical	PCB dimension shall the page 7/9				
	damage or elec-	F(Pressurization)				
	trical damege.	л				
		R5 45±2 45±2				
		PRESSURE ROD figure-1				
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board				
		and when a vibration having an amplitude of 1.52mm				
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should				
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.				
	damage.	(A total of 6 hours)				
Solderability	New solder	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated				
,	More than 90%	over the whole of the sample before hard, the sample shall				
		then be preheated for about 2 minutes in a temperature of				
		130 \sim 150 $^\circ\!\!\!\mathrm{C}$ and after it has been immersed to a depth 0.5mm				
		below for 3±0.2 seconds fully in molten solder M705 with				
		a temperature of 245±5℃.				
		More than 90% of the electrode sections shall be couered				
		with new solder smoothly when the sample is taken out of				
		the solder bath.				



MECHANICAL

TEST ITEM	SPECIFICATION					
Resistance to Soldering heat	There shall be no damage or problems.	SPECIFICATION Temperature profile of reflow soldering (Peak temperature 200:3° 10 sec 30 ec Mn 150 100 150 100 150 100 2 min 100 2 min 100 100 100 100 100 100 100 10				

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation	There shall be	DC 100V voltage shall be applied across this sample of top
resistance	no other	surface and the terminal.
	damage or	The insulation resistance shall be more than $1 \times 10^8 \Omega$.
	problems.	
Dielectric	There shall be	AC 100V voltage shall be applied for 1 minute acrosset the top
withstand	no other	surface and the terminal of this sample
voltage	damage or	
	problems.	
Temperature	∆L/L20℃ ≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be \triangle L/L20 $^\circ$ C \leq ±10%.



ENVIROMENT CHARACTERISTICS

TEST ITEM		SPECIFICATION					
High temperature	∆L/Lo≦±5%	\triangle L/Lo \leq ±5% The sample shall be left for 96±4 hours in an atmospere with					
storage		a temperature of 85±2 $^\circ\!\!\mathbb{C}$ and a normal humidity.					
	There shall be	Upon co	Upon completion of the measurement shall be made after the				
	no mechanical	sample	sample has been left in a normal temperature and normal				
	damage.	humidit	y for 1	hour.			
Low temperature	∆L/Lo≦±5%	The san	nple s	hall be left for 96±4 hou	rs in an atmosphere wi	th	
storage		a tempe	rature	e of -25±3℃.			
	There shall be	Upon co	omple	ion of the test, the mea	surement shall be mad	е	
	no mechanical	after the	e sam	ole has been left in a no	rmal temperature and		
	damage.	normal	humid	ity for 1 hour.			
Change of	∆L/Lo≦±5%	The san	nple s	hall be subject to 5 cont	tinuos cycles, such as s	shown	
temperature		in the ta	ble 2	below and then it shall b	be subjected to standa	rd	
	There shall be	atmosp	heric (conditions for 1 hour, af	ter which measuremen	t	
	no other dama-	shall be	made				
	ge of problems						
				table 2			
				Temperature	Duration		
			1	− 25±3° C	30 min.		
				(Themostat No.1)			
			2	Standard	No.1→No.2		
				atmospheric			
			3	85±2℃	30 min.		
				(Themostat No.2)			
			4	Standard	No.2→No.1		
				atmospheric			
Moisture storage	∆L/Lo≦±5%	The san	nple s	hall be left for 96±4 hou	rs in a temperature of		
		$40\pm2^{\circ}$ and a humidity(RH) of 90~95%.					
	There shall be	Upon completion of the test, the measurement shall be made					
	no mechanical	after the	after the sample has been left in a normal temperature and				
	damage.	normal	normal humidity more than 1 hour.				
Test conditions :		1					
The	sample shall be reflow	w soldered	l onto	the printed circuit boar	d in every test.		

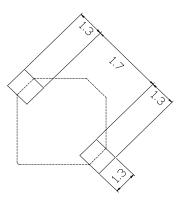


(5) LAND DIMENSION (Ref.)

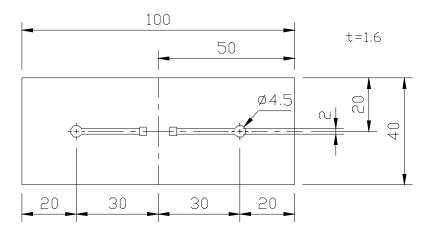
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN) Unit : mm

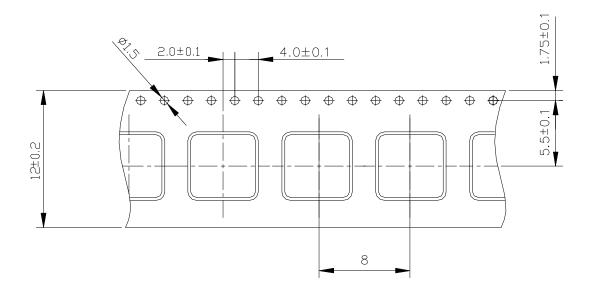


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

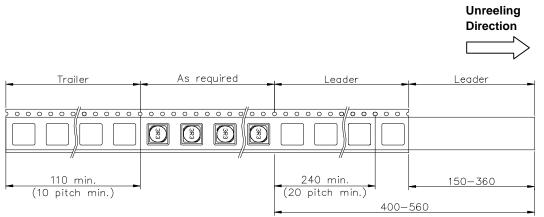




(6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)

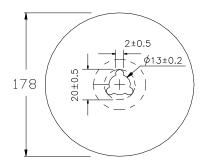


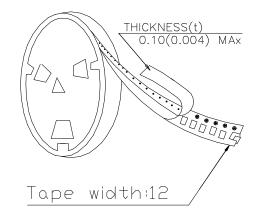
(6)-2 TAPING DIMENSIONS (mm)





(6)-3 REEL DIMENSIONS (mm)





(6)-4 QUANTITY

1000pcs/Reel

The products are packaged so that no damage will be sustained.

